

NCE N-Channel Enhancement Mode Power MOSFET

Description

The NCE6009XS uses advanced trench technology and design to provide excellent $R_{DS(ON)}$ with low gate charge. It can be used in a wide variety of applications.

General Features

V_{DS} = 60V,I_D =9A

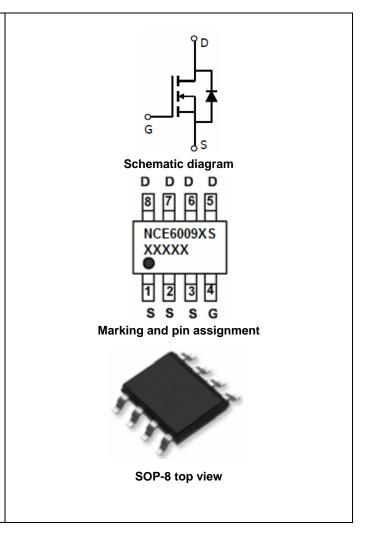
 $R_{DS(ON)} < 16 m\Omega @ V_{GS} = 10V \quad (Typ:9.3 m\Omega)$

 $R_{DS(ON)} < 18m\Omega$ @ V_{GS} =4.5V (Typ:12.7m Ω)

- High density cell design for ultra low Rdson
- Fully characterized avalanche voltage and current
- Low gate to drain charge to reduce switching losses

Application

- Power switching application
- Load switch



Package Marking and Ordering Information

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
NCE6009XS	NCE6009XS	SOP-8	-	-	-

Absolute Maximum Ratings (T_C=25 ℃unless otherwise noted)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V _{DS}	60	V	
Gate-Source Voltage	V _{GS}	±20	V	
Drain Current-Continuous	I _D	9	А	
Drain Current-Continuous(T _C =100 °C)	I _D (100℃)	6.4	А	
Pulsed Drain Current	I _{DM}	36	А	
Maximum Power Dissipation	P _D	2.6	W	
Operating Junction and Storage Temperature Range	T_{J} , T_{STG}	-55 To 150	°C	

Thermal Characteristic

Thermal Resistance, Junction-to-Ambient (Note 2)	$R_{ heta JA}$	48	°C/W
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Electrical Characteristics (TC=25°C unless otherwise noted)

Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	60		-	V
Zero Gate Voltage Drain Current	I _{DSS}	V_{DS} =60V, V_{GS} =0V	-	-	1	μA
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20 V , V_{DS} =0 V	-	-	±100	nA
On Characteristics (Note 3)	<u> </u>					•
Gate Threshold Voltage	V _{GS(th)}	$V_{DS}=V_{GS}$, $I_{D}=250\mu A$	1.2	1.8	2.2	V
Danier Courses On Otata Basintana	_	V _{GS} =10V, I _D =9A	-	9.3	16	mΩ
Drain-Source On-State Resistance	R _{DS(ON)}	V _{GS} =4.5V, I _D =9A	-	12.7	18	mΩ
Forward Transconductance	g Fs	V _{DS} =5V,I _D =9A	25	-	-	S
Dynamic Characteristics (Note4)	<u> </u>					•
Input Capacitance	C _{lss}	.,	-	2750	-	PF
Output Capacitance	Coss	V_{DS} =30V, V_{GS} =0V,	-	170	-	PF
Reverse Transfer Capacitance	C _{rss}	F=1.0MHz	-	152	-	PF
Switching Characteristics (Note 4)	<u> </u>					•
Turn-on Delay Time	t _{d(on)}		-	9	-	nS
Turn-on Rise Time	t _r	V_{DD} =30V, R_L =1 Ω	-	7	-	nS
Turn-Off Delay Time	t _{d(off)}	V_{GS} =10 V , R_{GEN} =3 Ω	-	32	-	nS
Turn-Off Fall Time	t _f		-	6	-	nS
Total Gate Charge	Qg	\/ 00\/ L 0A	-	60	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=30V,I_{D}=8A,$	-	10	-	nC
Gate-Drain Charge	Q _{gd}	V _{GS} =10V	-	14	-	nC
Drain-Source Diode Characteristics			•			•
Diode Forward Voltage (Note 3)	V _{SD}	V _{GS} =0V,I _S =9A	-	-	1.2	V
Diode Forward Current (Note 2)	Is	-	-	-	9	Α
Reverse Recovery Time	t _{rr}	TJ = 25°C, IF=9A	-	30	-	nS
Reverse Recovery Charge	Qrr	$di/dt = 100A/\mu s^{(Note3)}$	-	44	-	nC

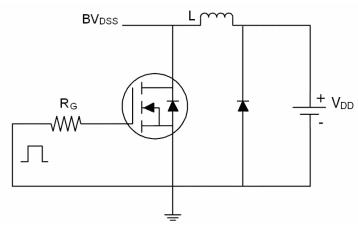
Notes:

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- **2.** Surface Mounted on FR4 Board, $t \le 10$ sec.
- **3.** Pulse Test: Pulse Width $\leq 300 \mu$ s, Duty Cycle $\leq 2\%$.
- 4. Guaranteed by design, not subject to production

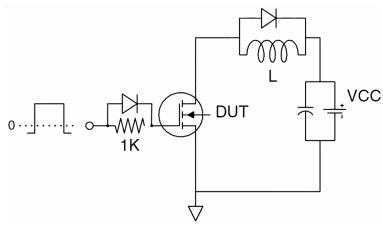


Test Circuit

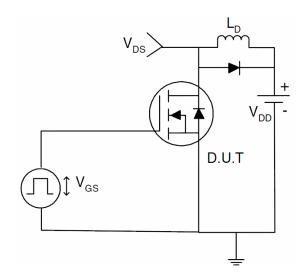
1) E_{AS} test Circuit



2) Gate charge test Circuit



3) Switch Time Test Circuit





Typical Electrical and Thermal Characteristics (Curves)

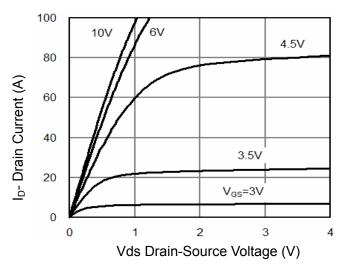


Figure 1 Output Characteristics

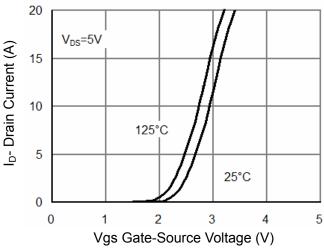


Figure 2 Transfer Characteristics

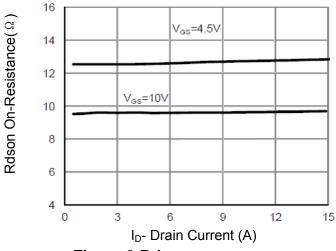


Figure 3 Rdson- Drain Current

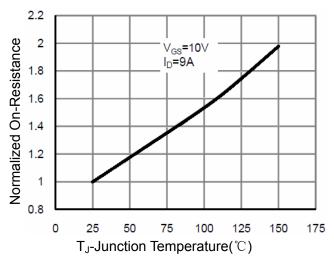


Figure 4 Rdson-JunctionTemperature

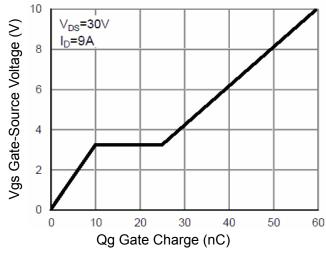


Figure 5 Gate Charge

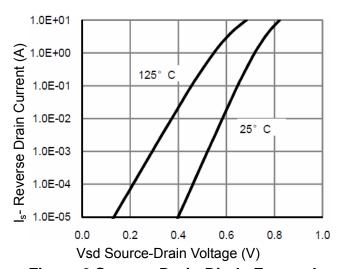
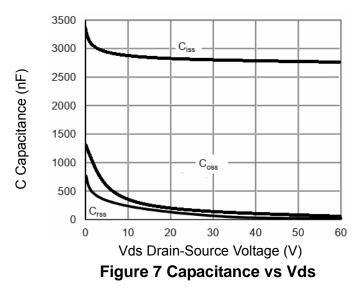


Figure 6 Source- Drain Diode Forward





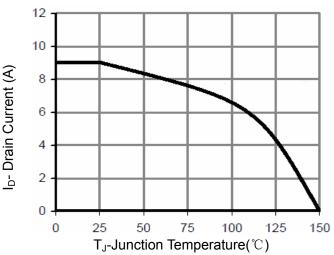
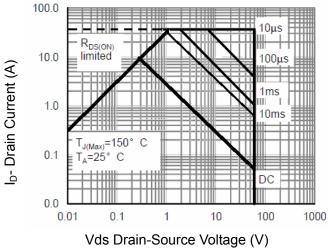


Figure 9 Current De-rating



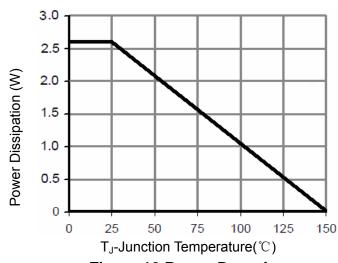


Figure 8 Safe Operation Area

Figure 10 Power De-rating

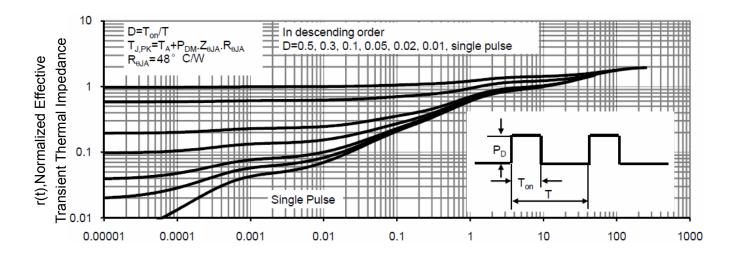
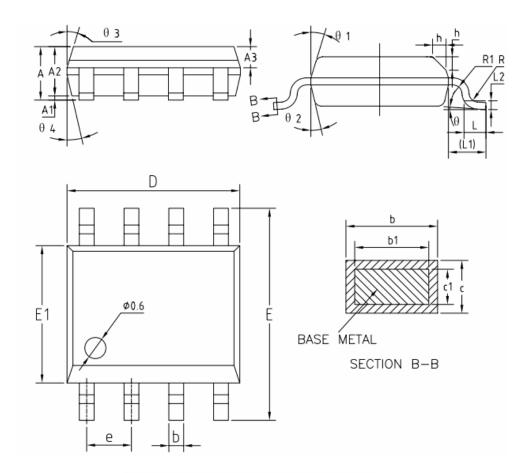


Figure 11 Normalized Maximum Transient Thermal Impedance

Square Wave Pluse Duration(sec)



SOP-8 Package Information



COMMON DIMENSIONS (UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX	
Α	1.35	1.55	1.75	
A1	0.10	0.15	0.25	
A2	1.25	1.40	1.65	
A3	0.50	0.60	0.70	
р	0.38	_	0.51	
b1	0.37	0.42	0.47	
С	0.18	_	0.25	
c1	0.17	0.20	0.23	
D	4.80	4.90	5.00	
E	5.80	6.00	6.20	
E1	3.80	3.90	4.00	
е	1.17	1.27	1.37	
L L1	0.45	0.60	0.80	
L1	1.04REF			
L2	0.25BSC			
R	0.07	_	-	
R1	0.07	_	_	
h	0.30	0.40	0.50	
θ	0.	_	8	
θ 1	15 *	17°	19 *	
θż	11*	13*	15°	
θ 3	15 °	17*	19 °	
θ 4	11*	13°	15 °	

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NCE6009XS

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